

Title (en)

CERAMIC CUTTING TEMPLATE

Title (de)

SCHNITTSCHABLONE AUS KERAMIK

Title (fr)

PATRON DE DÉCOUPAGE EN CÉRAMIQUE

Publication

**EP 2413816 A1 20120208 (DE)**

Application

**EP 10713617 A 20100401**

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- DE 102009002085 A 20090401

Abstract (en)

[origin: WO2010112588A1] The invention relates to a cutting template or a cutting block, preferably to a cutting template or a cutting block for use in medical technology.

IPC 8 full level

**A61B 17/15** (2006.01); **C04B 35/119** (2006.01)

CPC (source: EP KR US)

**A61B 17/155** (2013.01 - EP KR US); **A61B 17/1764** (2013.01 - KR); **A61L 31/124** (2013.01 - KR); **C04B 35/119** (2013.01 - KR);  
**C04B 35/44** (2013.01 - EP KR US); **C04B 35/6261** (2013.01 - EP US); **C04B 35/6263** (2013.01 - EP KR US); **C04B 35/6455** (2013.01 - EP US);  
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Citation (search report)

See references of WO 2010112588A1

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